# **MA6X718** (MA718)

### Silicon epitaxial planar type

#### For switching circuits

For wave detection circuit

#### Features

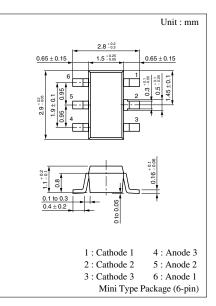
- Three MA3X704As in the same direction are contained in one package
- Optimum for low-voltage rectification because of its low forward rise voltage ( $V_F$ )
- Optimum for high-frequency rectification because of its short reverse recovery time (t<sub>rr</sub>)

#### Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit
Reverse voltage (DC)	V <sub>R</sub>	30	V
Peak forward current*	$I_{FM}$	150	mA
Forward current (DC)*	$I_F$	30	mA
Junction temperature	Tj	125	°C
Storage temperature	T <sub>stg</sub>	-55 to +125	°C

Note) \* : Value in per diode

#### Electrical Characteristics $T_a = 25^{\circ}C$



#### Marking Symbol: M2N

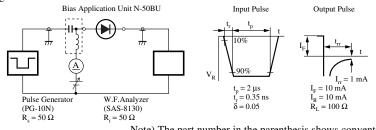
Internal Connection

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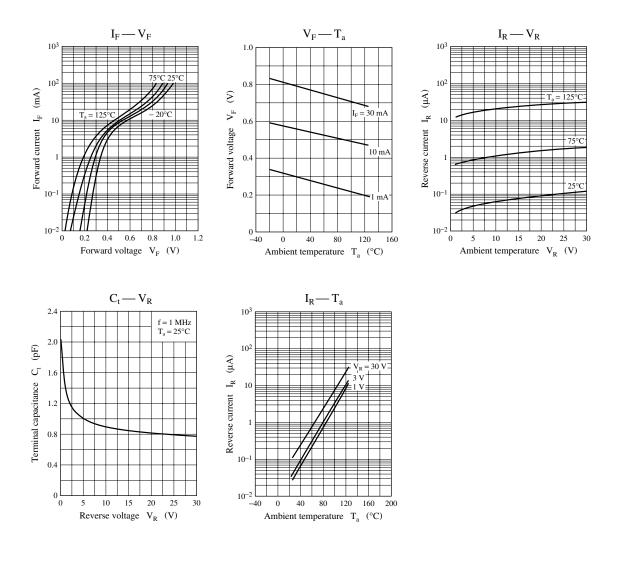
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Reverse current (DC)	I <sub>R</sub>	$V_R = 30 V$			1	μΑ
Forward voltage (DC)	V <sub>F1</sub>	$I_F = 1 \text{ mA}$			0.4	V
	V <sub>F2</sub>	$I_F = 30 \text{ mA}$			1.0	V
Terminal capacitance	Ct	$V_R = 1 V, f = 1 MHz$		1.5		pF
Reverse recovery time*	t <sub>rr</sub>	$I_F = I_R = 10 \text{ mA}$ $I_{rr} = 1 \text{ mA}, R_L = 100 \Omega$		1.0		ns
Detection efficiency	η	$V_{in} = 3 V_{(peak)}, f = 30 MHz$ $R_L = 3.9 k\Omega, C_L = 10 pF$		65		%

Note) 1. Schottky barrier diode is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment

- 2. Rated input/output frequency: 2 000 MHz
- 3. \*: t<sub>rr</sub> measuring instrument



Note) The part number in the parenthesis shows conventional part number.



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